FIG. 1

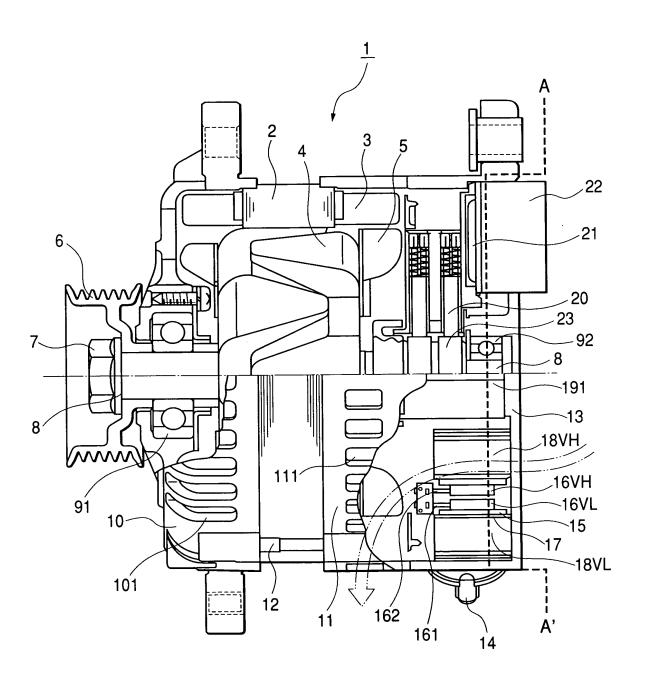
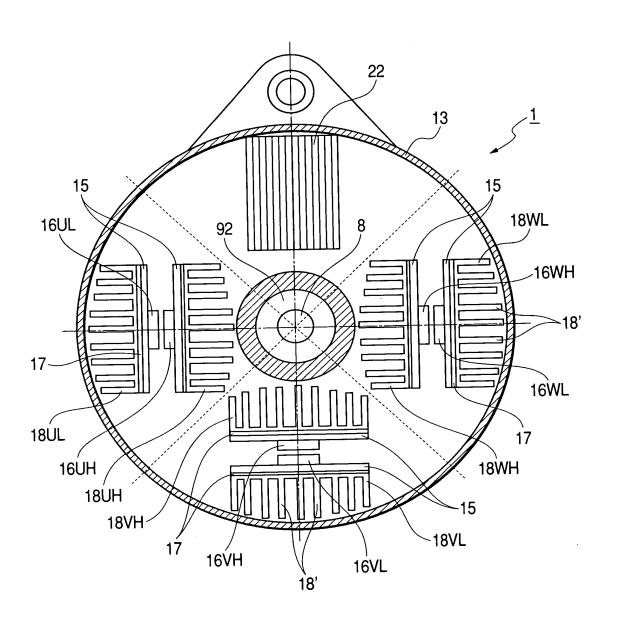
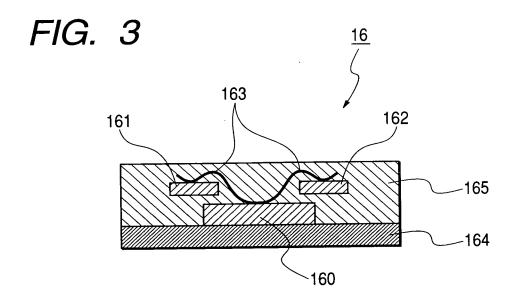


FIG. 2





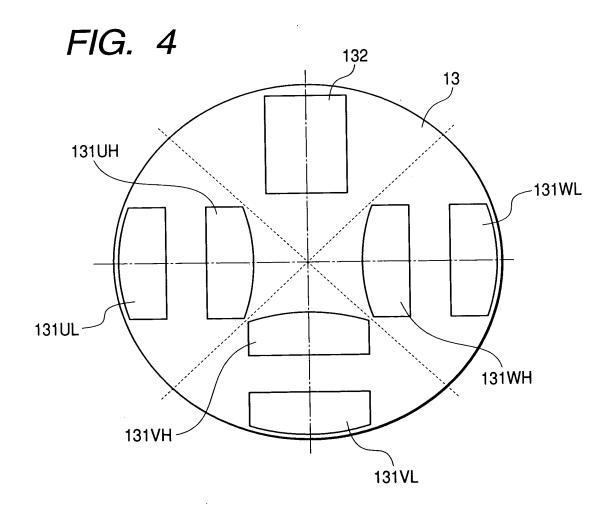


FIG. 5

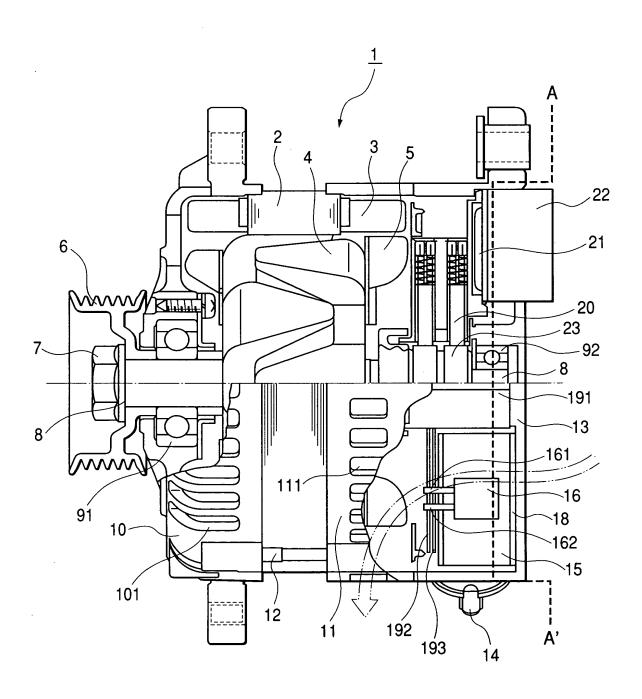


FIG. 6

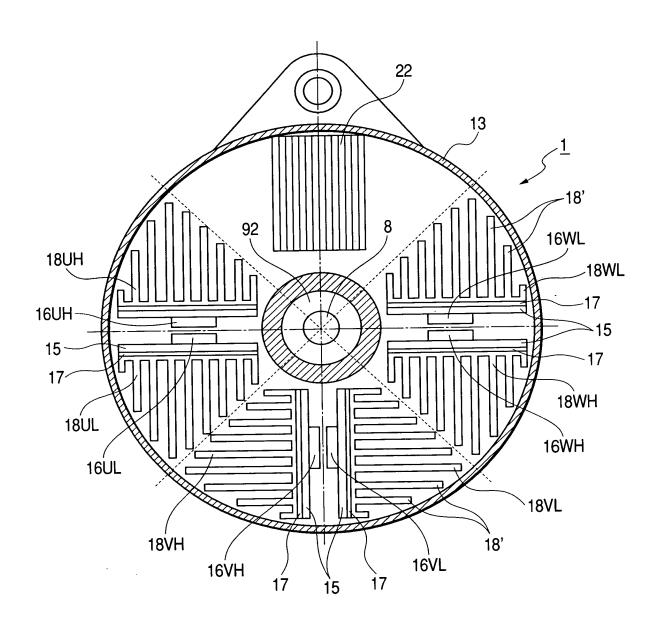
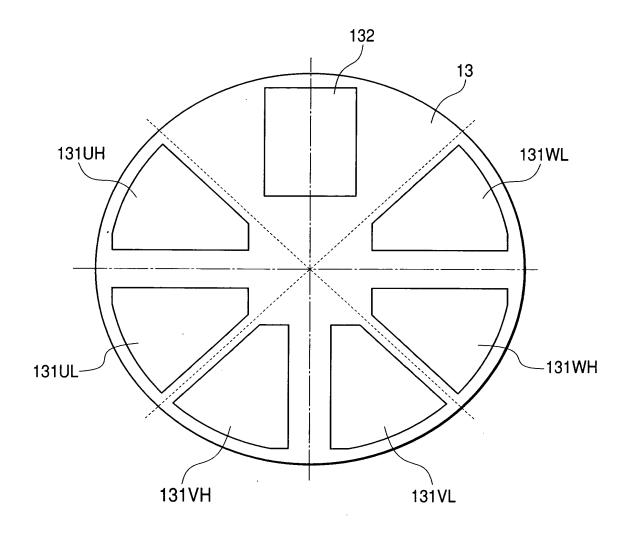
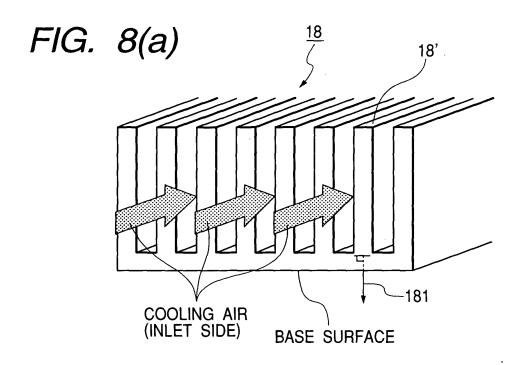
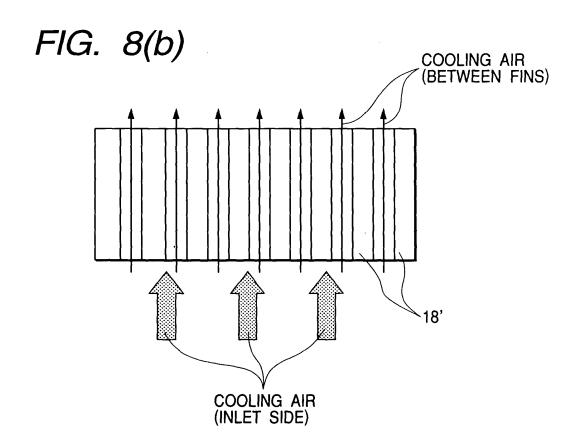
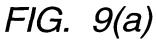


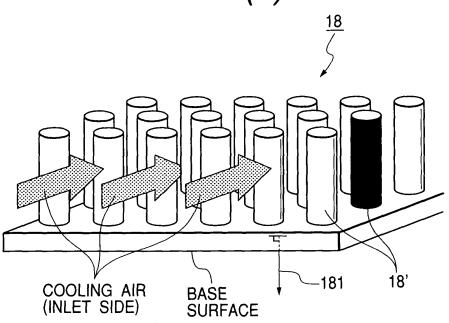
FIG. 7











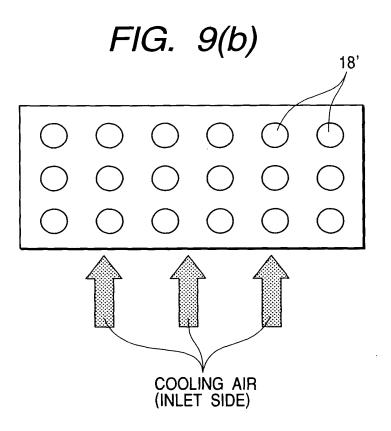


FIG. 10(a)

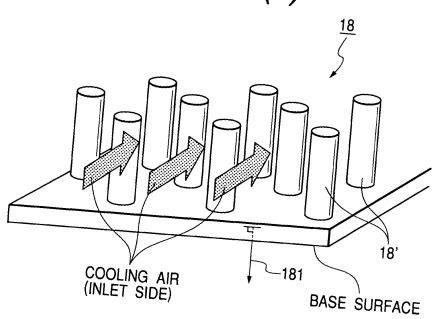


FIG. 10(b)

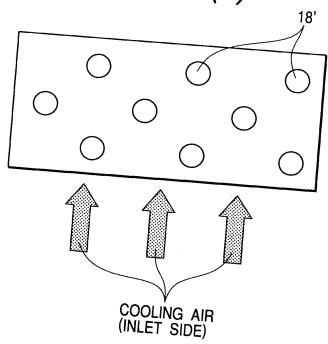


FIG. 11

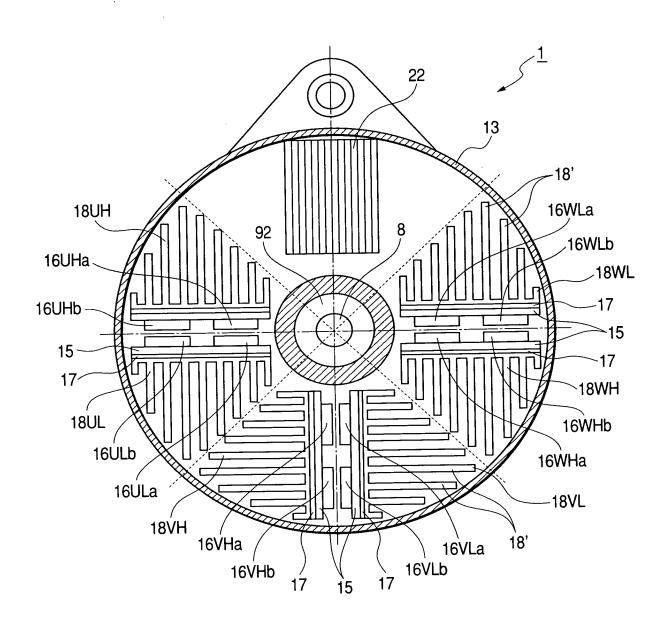


FIG. 12

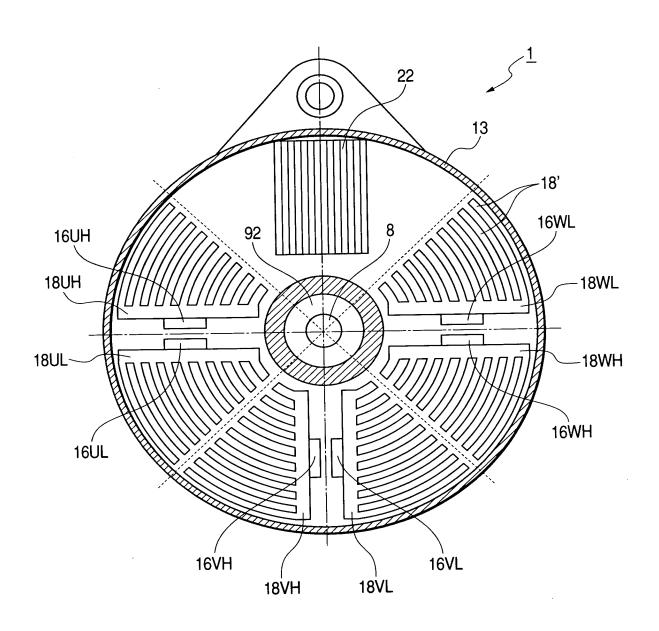


FIG. 13

	HN	nr	ΗΛ	۸۲	MH	WL	MAXIMUM TEMPERATURE DIFFERENCE (°C) BETWEEN DEVICES
CONVENTIONAL EXAMPLE	185.9	181.2	189.5	180.0	187.6	178.0	11.5
EMBODIMENT 1 (1 DEVICE/ 1 HEAT SINK)	156.3	155.2	157.9	155.4	157.5	154.9	3.0
EMBODIMENT 2 (1 DEVICE/ 1 HEAT SINK)	151.1	151.5	150.8	151.3	150.9	150.6	0.9
EMBODIMENT 3 (2 DEVICES/ 1 HEAT SINK)	160.5 161.0	161.2 161.5	161.3 161.4	160.5 161.0 161.2 161.5 161.3 161.4 160.2 161.8 160.9 161.5 160.8 160.3	160.9 161.5	160.8 160.3	1.5
EMBODIMENT 4 (1 DEVICE/ 1 HEAT SINK)	145.6	146.5	145.0	146.6	146.3	147.0	2.0